

Amendments to the Claims:

The following listing of claims replaces all prior versions and listings of claims in the application:

1-29. (Canceled)

30. (Currently Amended) An apparatus comprising:

an electronic device having an outer surface and a first and second conductive termination on the surface for connection to an external circuit, wherein at least the second conductive termination comprises a plurality of conductive terminations;

a protective, conformal coating on the outer surface of the electronic device; ~~and~~

a first window formed in the protective coating that exposes at least a portion of the first conductive termination without exposing any other conductive ~~termination~~ terminations on the surface of the electronic device, wherein the exposed portion of the conductive termination is recessed in the first window of the conformal coating, the first window defining a boundary for a solder connection between the external circuit and the first conductive termination; and .

a second window comprising a plurality of openings exposing a respective portion of a respective one of the plurality of conductive terminations, wherein each exposed respective portion is recessed within a respective one of the plurality of openings in the protective coating, each respective one of the plurality of openings defining a boundary for a respective solder connection between the external circuit and the respective one of the plurality of conductive terminations.

31. (Previously Presented) The apparatus of claim 30 wherein the coating comprises a uniform thickness.

32. (Previously Presented) The apparatus of claim 30 wherein the coating conforms to the geometric configuration of the electronic device.

33. (Previously Presented) The apparatus of claim 30 wherein the coating comprises a polymer.

34. (Previously Presented) The apparatus of claim 33 wherein the polymer comprises poly-para-xylylene.

35. (Previously Presented) The apparatus of claim 30 wherein the electronic device comprises an integrated power device (IPD).

36. (Previously Presented) The apparatus of claim 30 wherein the electronic device further comprises a semiconductor.

37. (Previously Presented) The apparatus of claim 30 wherein the electronic device further comprises power semiconductor.

38-40. (Canceled)